

Three Phase Bridge (Power Modules), 25/35 A



D-63

FEATURES

- Universal, 3 way terminals: push-on, wrap around or solder
- High thermal conductivity package, electrically insulated case
- Center hole fixing
- Excellent power/volume ratio
- UL E300359 approved
- Gold plated terminals solderable using lead (Pb)-free solder; solder alloy Sn/Ag/Cu (SAC305); solder temperature 260 to 275 °C
- RoHS compliant
- Designed and qualified for industrial and consumer level


RoHS
COMPLIANT

PRODUCT SUMMARY

I_o	25/35 A
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DESCRIPTION

A range of extremely compact, encapsulated three phase bridge rectifiers offering efficient and reliable operation. They are intended for use in general purpose and instrumentation applications.

MAJOR RATINGS AND CHARACTERISTICS

SYMBOL	CHARACTERISTICS	26MT	36MT	UNITS
I_o		25	35	A
	T_c	70	60	°C
I_{FSM}	50 Hz	360	475	A
	60 Hz	375	500	
I^2t	50 Hz	635	1130	A ² s
	60 Hz	580	1030	
V_{RRM}		100 to 1600		V
T_J		- 55 to 150		°C

ELECTRICAL SPECIFICATIONS
VOLTAGE RATINGS

TYPE NUMBER	VOLTAGE CODE	V_{RRM} , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V	V_{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I_{RRM} MAXIMUM AT T_J MAXIMUM mA
26MT../36MT..	10	100	150	2
	20	200	275	
	40	400	500	
	60	600	725	
	80	800	900	
	100	1000	1100	
	120	1200	1300	
	140	1400	1500	
	160	1600	1700	

FORWARD CONDUCTION							
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES		UNITS	
				26MT	36MT		
Maximum DC output current at T_C	I_O	120° rect. conduction angle		25	35	A	
				70	60	°C	
Maximum peak, one-cycle non-repetitive forward current	I_{FSM}	t = 10 ms	No voltage reapplied	Initial $T_J = T_J$ maximum	360	475	A
		t = 8.3 ms			375	500	
		t = 10 ms	100 % V_{RRM} reapplied		300	400	
		t = 8.3 ms			314	420	
Maximum I^2t for fusing	I^2t	t = 10 ms	No voltage reapplied		635	1130	A ² s
		t = 8.3 ms			580	1030	
		t = 10 ms	100 % V_{RRM} reapplied		450	800	
		t = 8.3 ms			410	730	
Maximum $I^2\sqrt{t}$ for fusing	$I^2\sqrt{t}$	I^2t for time $t_x = I^2\sqrt{t} \times \sqrt{t_x}$; $0.1 \leq t_x \leq 10$ ms, $V_{RRM} = 0$ V		6360	11 300	A ² √s	
Low level of threshold voltage	$V_{F(TO)1}$	$(16.7\% \times \pi \times I_{F(AV)} < I < \pi \times I_{F(AV)})$, T_J maximum		0.88	0.86	V	
High level of threshold voltage	$V_{F(TO)2}$	$(I > \pi \times I_{F(AV)})$, T_J maximum		1.13	1.03		
Low level forward slope resistance	r_{t1}	$(16.7\% \times \pi \times I_{F(AV)} < I < \pi \times I_{F(AV)})$, T_J maximum		7.9	6.3	mΩ	
High level forward slope resistance	r_{t2}	$(I > \pi \times I_{F(AV)})$, T_J maximum		5.2	5.0		
Maximum forward voltage drop	V_{FM}	$T_J = 25$ °C, $I_{FM} = 40$ Apk - per single junction		1.26	1.19	V	
Maximum DC reverse current	I_{RRM}	$T_J = 25$ °C, per junction at rated V_{RRM}		100		μA	
RMS isolation voltage	V_{INS}	$T_J = 25$ °C, all terminal shorted; f = 50 Hz, t = 1 s		2700		V	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES		UNITS
				26MT	36MT	
Maximum junction and storage temperature range	T_J, T_{Stg}			- 55 to 150		°C
Maximum thermal resistance, junction to case	R_{thJC}	DC operation per bridge (based on total power loss of bridge)		1.42	1.35	K/W
Maximum thermal resistance, case to heatsink	R_{thCS}	Mounting surface, smooth, flat and greased		0.2	0.2	
Approximate weight				20		g
Mounting torque ± 10 %		Bridge to heatsink with screw M4		2.0		Nm



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Vishay High Power Products

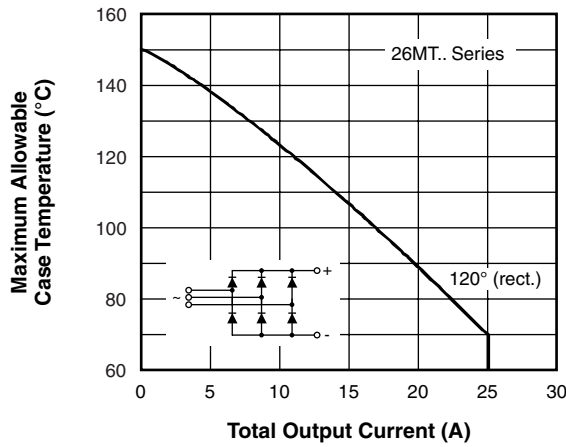


Fig. 1 - Current Ratings Characteristics



Fig. 2 - Forward Voltage Drop Characteristics

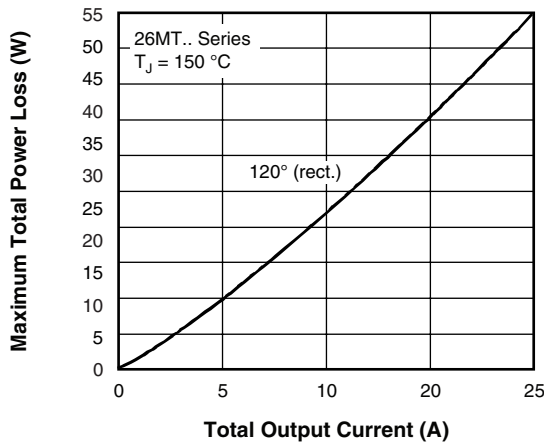


Fig. 3 - Total Power Loss Characteristics



Fig. 4 - Maximum Non-Repetitive Surge Current



Fig. 5 - Maximum Non-Repetitive Surge Current

26MT../36MT.. Series



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Fig. 6 - Current Ratings Characteristics



Fig. 7 - Forward Voltage Drop Characteristics

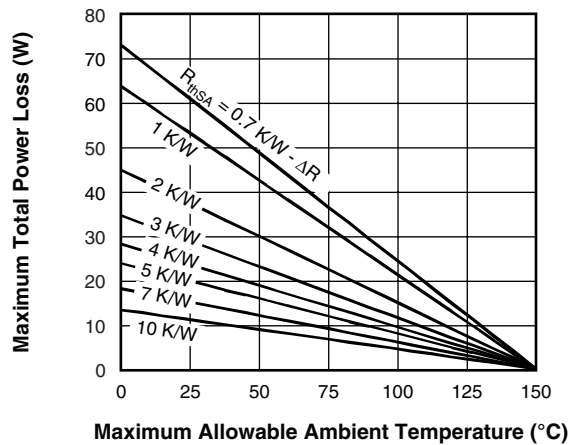


Fig. 8 - Total Power Loss Characteristics



Fig. 9 - Maximum Non-Repetitive Surge Current

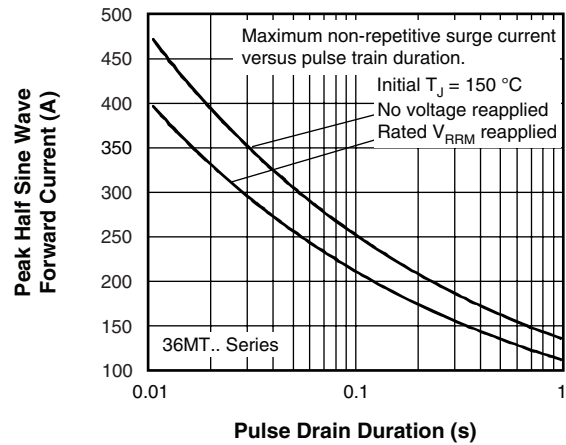


Fig. 10 - Maximum Non-Repetitive Surge Current

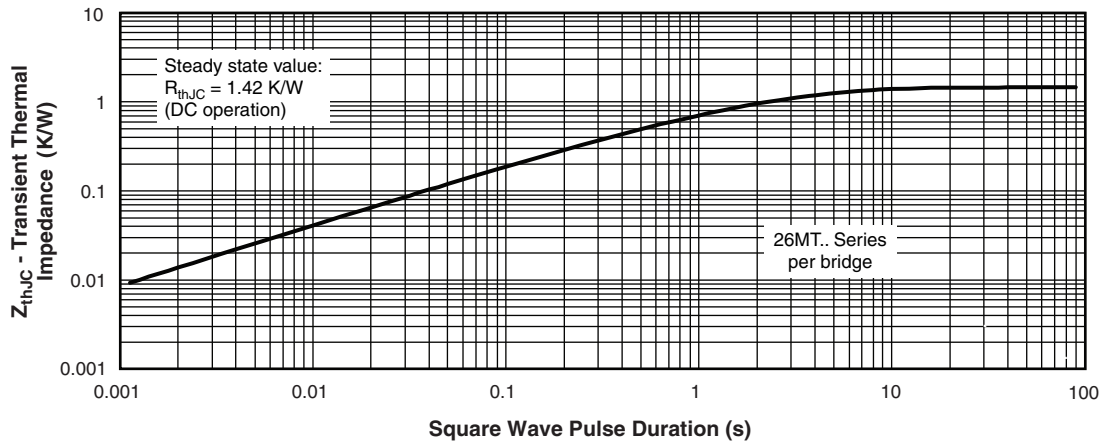


Fig. 11 - Thermal Impedance Z_{thJC} Characteristics



Fig. 12 - Thermal Impedance Z_{thJC} Characteristics



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